



4314-15

Nixon & Vandernye P.C. (10/99)  
(Domestic Assigned) Page 1

RULE 63 (37 C.F.R. 1.63)  
INVENTORS DECLARATION FOR PATENT APPLICATION  
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

As a below named inventor, I hereby declare that my residence, mailing address and citizenship are as stated below next to my name, and I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

TITANIUM ALLOY MICROSTRUCTURAL REFINEMENT METHOD AND HIGH TEMPERATURE, HIGH STRAIN RATE SUPERPLASTIC FORMING OF TITANIUM ALLOYS

the specification of which (check applicable box(es)):

☐ is attached hereto  
☒ was filed on June 7, 2006 as U.S. Application Serial No. 10/581,998 (Atty. Dkt. No. 4314-15)  
☐ was filed as PCT International application No. on  
and (if applicable to U.S. or PCT application) was amended on

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose to the Patent Office all information known to me to be material to patentability as defined in 37 C.F.R. 1.56. I hereby claim foreign priority benefits under 35 U.S.C. 119/365 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed or, if no priority is claimed, before the filing date of this application:

Priority Foreign Application(s):  
Application Number Country Day/Month/Year Filed

I hereby claim the benefit under 35 U.S.C. §119(e) of any United States provisional application(s) listed below.  
Application Number Day/Month/Year Filed  
60/528,660 December 11, 2003

I hereby claim the benefit under 35 U.S.C. 120/365 of all prior United States and PCT international applications listed above or below  
Prior U.S./PCT Application(s): Day/Month/Year Filed Status: patented  
Application Serial No. pending, abandoned  
PCT/US2004/041623 December 13, 2004

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. And on behalf of the owner(s) hereof, I hereby ask that all correspondence in this matter be directed to:

Customer Number: 23117

1. Inventor's Signature: [Signature] Date: 14 Sep 2007  
Inventor: Daniel B. Miracle  
(first) (last) USA  
(citizenship)  
Residence: (city) Bellbrook (state/country) Ohio  
Mailing Address: 2237 Shadowood Circle, Bellbrook Ohio  
(Zip Code) 45305

2. Inventor's Signature: [Signature] Date: 09/13/07  
Inventor: Seshacharyulu Tamirakandala  
(first) (last) INDIA  
(citizenship)  
Residence: (city) Beavercreek (state/country) Ohio  
Mailing Address: 2634 Thomas Jefferson Drive, Beavercreek, Ohio  
(Zip Code) 45434

**[X] See attached sheet(s) for additional inventor(s) information!!**

RULE 63 (37 C.F.R. 1.83)  
INVENTORS DECLARATION FOR PATENT APPLICATION  
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

3. Inventor's Signature: [Signature] Date 17 Sept 2007  
Inventor: Radhakrishna B. MI Shat INDIA  
(first) (last) (citizenship)  
Residence (city): Beavercreek (state/country) Ohio  
Mailing Address: 2388 Edgewater Drive  
(Zip Code) 45431
4. Inventor's Signature: [Signature] Date 13 Sept 2007  
Inventor: Jaimie S TILEY USA  
(first) (last) (citizenship)  
Residence (city): Verona (state/country) Ohio  
Mailing Address: 220 South State Street  
(Zip Code) 45309
5. Inventor's Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
Inventor: \_\_\_\_\_ (first) \_\_\_\_\_ MI \_\_\_\_\_ (last) \_\_\_\_\_ (citizenship)  
Residence (city): \_\_\_\_\_ (state/country) \_\_\_\_\_  
Mailing Address: \_\_\_\_\_  
(Zip Code) \_\_\_\_\_
6. Inventor's Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
Inventor: \_\_\_\_\_ (first) \_\_\_\_\_ MI \_\_\_\_\_ (last) \_\_\_\_\_ (citizenship)  
Residence (city): \_\_\_\_\_ (state/country) \_\_\_\_\_  
Mailing Address: \_\_\_\_\_  
(Zip Code) \_\_\_\_\_
7. Inventor's Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
Inventor: \_\_\_\_\_ (first) \_\_\_\_\_ MI \_\_\_\_\_ (last) \_\_\_\_\_ (citizenship)  
Residence (city): \_\_\_\_\_ (state/country) \_\_\_\_\_  
Mailing Address: \_\_\_\_\_  
(Zip Code) \_\_\_\_\_
8. Inventor's Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
Inventor: \_\_\_\_\_ (first) \_\_\_\_\_ MI \_\_\_\_\_ (last) \_\_\_\_\_ (citizenship)  
Residence (city): \_\_\_\_\_ (state/country) \_\_\_\_\_  
Mailing Address: \_\_\_\_\_  
(Zip Code) \_\_\_\_\_
9. Inventor's Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
Inventor: \_\_\_\_\_ (first) \_\_\_\_\_ MI \_\_\_\_\_ (last) \_\_\_\_\_ (citizenship)  
Residence (city): \_\_\_\_\_ (state/country) \_\_\_\_\_  
Mailing Address: \_\_\_\_\_  
(Zip Code) \_\_\_\_\_

ADDITIONAL INVENTORS, check box ☐ and attach sheet with same information and signature and date for each.

114488